



Data Sheet

Customer:	
Part No:	CL-SFC520DWW-3K-01(+)
Sample No:	
Description:	5050 SMD White Color
Item No:	

Customer					
Check Inspection Approval Date					





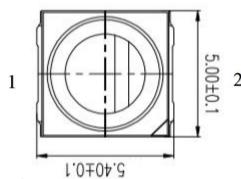
Features:

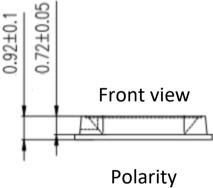
- . Reflow Solderable
- . High Luminous Intensity and Low Power Dissipation
- . Good Reliability and Long Life
- . Complied With RoHS Directive

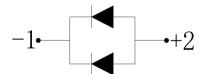
Applications

- Optical indicator
- Indoor display
- Backlighting in dashboard and switch
- Flat backlighting for LCD, symbol and display
- General use

Top view

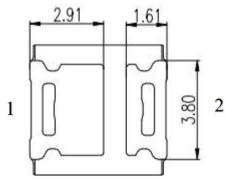




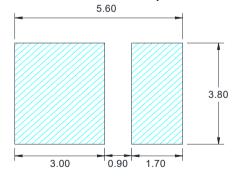


Pb

Bottom view



Recommended pad



Notes:

- 1 . All dimension units are millimeters.
- 2. All dimension tolerance is ±0.2mm unless otherwise noted.

REV NO: A/3 Page :1 of 10





Selection Guide

Part No.		Lens Type	Luminous intensity(cd) @100mA			Viewing Angle
Tare 140.	Color Color		Min	Тур	Max	201/2
CL-SFC520DWW-3K-01(+)	White	Yellow Diffused		12		120

Note:

1.201/2 is the angle from optical centerline where the luminous intensity is 201/2 the optical centerline value.

2. The above luminous intensity measurement allowance tolerance $\pm 10\%$

Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Min.	Тур.	Max	Units	test conditions
Forward Voltage	VF	2.8		3.4	V	IF=100mA
Reverse Current	IR			10	uA	VR = 5V
Color Rndering Index	Ra	80			/	IF=100mA
Color Temperature	Тс	2800		3200	K	IF=100mA

Note:

- 1. The above forward voltagemeasurement allowance tolerance $\pm 0.1 V$.
- 2. Ra measurement tolerance is ± 1
- 3. Measurement error of color temperature $\pm 100 K$

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Units
Power Dissipation	Pd	550	W
DC Forward Current	IF	150	mA
Peak Forward Current [1]	IFP	300	mA
Reverse Voltage	VR	5	V
Electrostatic Discharge (HBM)	ESD	2000	V
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	Tstg	-40~+100	°C

Note:

1. 1/10 Dut cycle,0.1ms pulse width.

REV NO: A/3 Page :2 of 10





IV Spec. Table

TV Opec. Table							
	Luminous Intensity(IV)						
BIN CODE MIN MAX Unit IF							
a	10	11					
ь	11	12	ad	100mA			
c	12	13	cd	TOOMA			
d	13	14					

Tolerance on each Intensity bin is:+/-15%

VF Spec. Table

VI Opec. I able							
Forward Voltage(VF)							
BIN CODE	MIN	MAX	Unit	IF			
VD1	2.8	2.9					
VD2	2.9	3.0					
VD3	3.0	3.1	V	100mA			
VD4	3.1	3.2	ľ	TOOTHA			
VE1	3.2	3.3					
VE2	3.3	3.4					

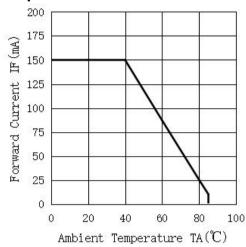
Tolerance on each Forward Voltage bin is:+/-0.1V

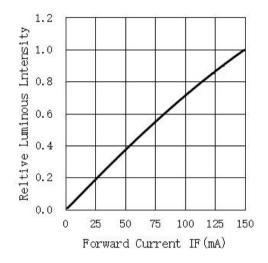
REV NO: A/3 Page :3 of 10

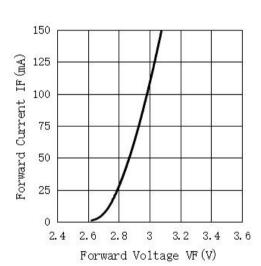


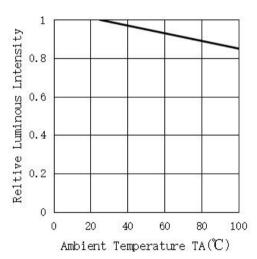


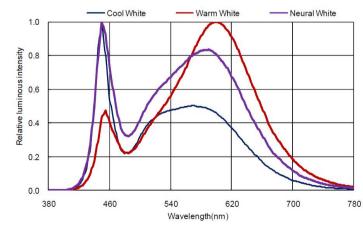
Typical optical characteristics curves

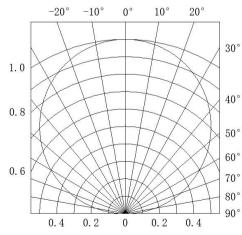










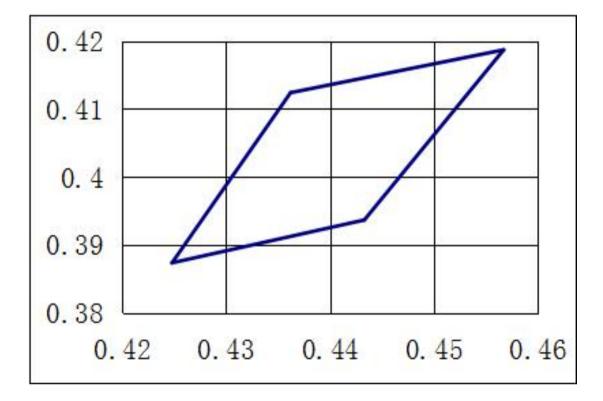


REV NO: A/3 Page :4 of 10





Bin Color



BIN	X	Y
	0.4362	0.4124
-2000-5-5	0.4567	0.4187
F306	0.4433	0.3937
***************************************	0.4248	0.3874
į.	0.4362	0.4124

Notes: Measurement Uncertainty of the Color Coordinates : ± 0.01 .

REV NO: A/3 Page 5 of 10





Reliability Test Items And Conditions

Test Items	Ref.Standard	Test conditions	Time	Quantity	Ac/Re
Reflow Soldering	JESD22-B106	Temp.:250°C±5°C Min.5sec.	6 times.	22Pcs.	0/1
Temperature Cycle	JESD22-A104	100°C±5°C 30 min. ↑↓5 min -40°C±5°C 30 min.	100 Cycles	22Pcs.	0/1
High Temperature Storage	JESD22-A103	Temp:100 °C±5 °C	1000Hrs	22Pcs.	0/1
Low Temperature Storage	JESD22-A119	Temp:-40°C±5°C	1000Hrs	22Pcs.	0/1
Life Test	JESD22-A108	Ta=25°C±5°C IF=100mA	1000Hrs	22Pcs.	0/1
High temperature and high humidity storage experiment	JESD22-A101	85°C±5°C/ 85%RH	1000Hrs	22Pcs.	0/1

Criteria For Judging Damage

Test Items	Symbol	Test conditions	Criteria For Judgement		
	•		Min.	Max.	
Forward Voltage	VF	IF=100mA		U.S.Lx1.1	
Reverse Current	IR	VR = 5V		U.S.Lx2.0	
Luminous intensity	IV	IF=100mA	L.S.Lx0.7		

U.S.L: Upper standard level

L.S.L: Lower standard level

The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.

REV NO: A/3 Page :6 of 10

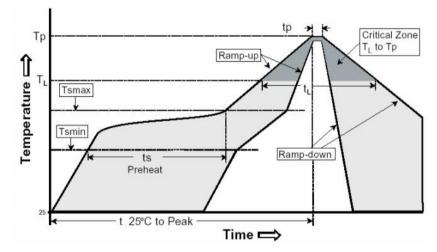




SMT Reflow Soldering Instructions

- 1. The number of reflow soldering shall not exceed two times,and the time from the second processing to the first completion shall not exceed 24H
- 2. When soldering, do not put stress on the LEDs during heating .(JEDEC J-STD-020D.1)

Duo Clo Footono	Sn-Pb Eutec	tic Assembly	Pb-Free Assembly		
Profile Feature	Large Body	e Body Small Body Large Body Sm		Small Body	
Average ramp-up rate (TL to Tp)	3°C/seco	ond max.	3°C/second max.		
Preheat -Temperature Min(TSmin) -Temperature Max(TSmax) -Time(min to max)(ts)	100°C 150°C 60-120 seconds		150°C 200°C 60-180 seconds		
Tsmax to TL -Ramp-up Rate			3°C/seco	ond max.	
Time maintained above: -Temperature(TL) -Time(tL)	183 60-150	3℃ seconds	217°C 60-150 seconds		
Peak Temperature(Tp)	225+0/-5°C	240+0/-5℃	245+0/-5℃	250+0/-5℃	
Time within 5°C of actual Peak Temperature(tp)	10-30 seconds	10-30 seconds	10-30 seconds	20-40 seconds	
Ramp-down Rate	6°C/second max.		6°C/second max.		
Time 25 °C to Peak Temperatur	r 6 minutes max. 8 minutes max		es max.		

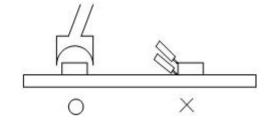


Soldering iron

- 1. When hand soldering, the temperature of the iron must less than 350°C for 3 seconds
- 2. The hand solder should be done only one times

Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used(as below figure). It should be confirmed in advance whether the characteristics of LEDs will or will not be damaged by repairing.



REV NO: A/3 Page :7 of 10





Storage

This product uses sealing anti-moisture antistatic packaging, and with desiccant, humidity card.

Before packaging is opened:

- 1. The storage environment is: the ambient temperature should be maintained between 5 ° C and 30 ° C, and the relative humidity should be kept within 60% RH. (Shelf life is 2 months. If more than two months, please use after baking, baking conditions: 65 ° C / 24H. If more than 6 months, please return the product to our company to assist in dehumidification)
 - 2. Please check the package for leaks before opening. If there is a leak, return to the factory for dehumidification.

After opening the package:

- 1. After opening the package, check whether the humidity card has a discoloration phenomenon. Please remove the material from the bag and use it after dehumidifying 24H at 65 °C.
- 2. Environmental conditions: The ambient temperature should be kept between ≤ 30 ° C and relative humidity The lower 60 % RH should be maintained.
- 3. if the material is not produced after exposure in the workshop for more than 24 hours, the product must be put back in the oven, dehumidified with 65 °C 24H, and then can be used again. If the material is not produced after 48 hours of exposure in the workshop, return the material to the SMD plant for high temperature dehumidification.
- 4. When the material is dehumidified, please do not open the oven in the middle, so that the oven temperature will not drop to the dehumidification effect.

Please refer to the following operating methods when the material needs to be dehumidified



Correct way: material desiccant need to remove the bag, use the way of hanging baked

正确的方法: 材料需要去掉袋子, 使用挂烤的方式烘烤。





Wrong way: the material is dehumidified without removing the bag, in a stacking manner

错误的做法是: 以堆叠方式或材料不取出袋子烘烤。

REV NO: A/3 Page:8 of 10





ESD

Static Electrisity will damage the LED.

The following steps can reduce the likelihood of ESD causing product damage

- 1.All productive machinery and test instruments must be electrically grounded.
- 2.Use a condustive wrist band or anti-electostatic glove when handling these LEDs.
- 3. Manintain a humidity level of 50%RHor higher in production areas.
- 4.Use anti-static packaging for transport and storage.

Handling Precautions

1.Do not stack the assembled PCB together. This may scratch the surface of the product or damage the circuit.



2. Not available in the situation of acidity for PH.



3. Electrostatic sensitive device

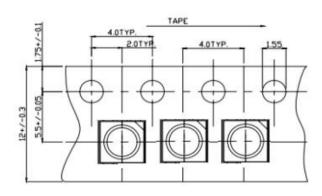


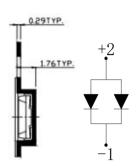
REV NO: A/3 Page :9 of 10



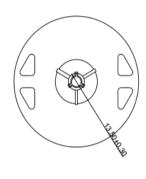


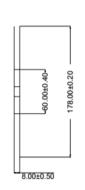
Carrier tape



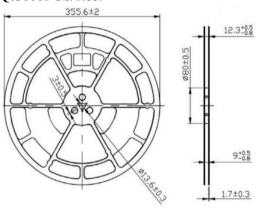


MPQ:1000PCS/Reel

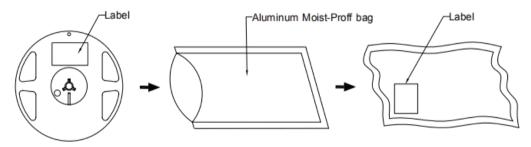




SPQ:5000PCS/Reel

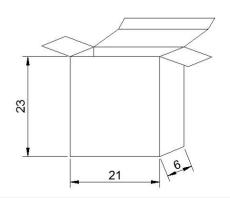


Moisture Resistant Packaging

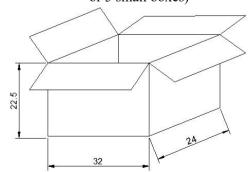


Cardboard Box

Maximum packing quantity (5 packs of material)



Maximum packing quantity (27 bags of material or 5 small boxes)



Page :10 of 10